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## In the Claims:

1. (Original) A semiconductor wafer having an asymmetric edge profile (EP) extending between an inner edge profile (EP<sub>in</sub>) and an outer edge profile (EP<sub>out</sub>) as illustrated by FIG. 1, which is incorporated herein;

wherein t is a thickness of the semiconductor wafer,  $\phi_1$  is an angle in a range between about 30° and about 85°, R is a radius of an arc that defines  $EP_{in}$  at a point of intersection with a top surface of the semiconductor wafer, and  $\alpha$  is an acute angle that represents an angle of intersection between a bottom surface of the semiconductor wafer and a line that is tangent to the arc at a point on  $EP_{out}$ ; and

10 wherein:

$$A_1$$
=R(1-cos $\phi_1$ );  
 $A_2$ =R(1-sin $\alpha$ ) + (t-Rsin $\phi_1$  - Rcos $\alpha$ )cot $\alpha$ ;  
 $B_1$ =Rsin $\phi_1$ ; and  
 $B_2$ =t-Rsin $\phi_1$ .

- 2. (Original) The wafer of Claim 1, wherein R is in a range between about 0.23t and about 0.5t.
- 3. (Original) The wafer of Claim 2, wherein  $A_2$  is greater than about two times  $A_1$ .
- 4. (Original) The wafer of Claim 2, wherein  $\phi_1$  is in a range between about 60° and about 75°.
- 5. (Original) The wafer of Claim 2, wherein t is in a range between about  $625 \mu m$  and about  $825 \mu m$ .

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- 6. (Original) A semiconductor wafer having an asymmetric edge profile (EP) extending between an inner edge profile (EP $_{in}$ ) and an outer edge profile (EP $_{out}$ ) as illustrated by FIG. 1, which is incorporated herein; wherein  $\phi_1$  is an angle in a range between about 30° and about 85°; and wherein R is in a range between about 0.23t and about 0.5t.
- 7. (Original) The wafer of Claim 6, wherein  $A_2$  is greater than about two times  $A_1$ .
- <u>8.</u> (Original) The wafer of Claim 6, wherein  $\phi_1$  is in a range between about <u>60°</u> and about 75°.
- 9. (Original) The wafer of Claim 6, wherein t is in a range between about 625 μm and about 825 μm.
- 10. (Original) A semiconductor wafer having an asymmetric edge profile (EP) extending between an inner edge profile (EP<sub>in</sub>) and an outer edge profile (EP<sub>out</sub>) as illustrated by FIG. 1, which is incorporated herein.

## 11.-17. (Canceled)

18. (Original) A semiconductor wafer having an asymmetric edge profile (EP2) extending between an inner edge profile (EP2 $_{in}$ ) and an outer edge profile (EP2 $_{out}$ ) as illustrated by FIG. 2, which is incorporated herein; wherein  $\varphi_1$  and  $\varphi_2$  are angles in a range between about 30° and about 85°; wherein  $\varphi_1 < \varphi_2$ ; and wherein R is in a range between about 0.23t and about 0.5t.

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19. A semiconductor wafer having an asymmetric edge profile (EP2) extending between an inner edge profile (EP2<sub>in</sub>) and an outer edge profile (EP2<sub>out</sub>) as illustrated by FIG. 2, which is incorporated herein;

wherein t is a thickness of the semiconductor wafer,  $\phi_1$  is an angle in a range between about 30° and about 85°,  $\phi_2$  is greater than  $\phi_1$  and less than about 85°, R is a radius of an arc that defines EP2<sub>in</sub> at a point of intersection with a top surface of the semiconductor wafer, and  $\alpha$  is an acute angle that represents an angle of intersection between a bottom surface of the semiconductor wafer and a line that is tangent to the arc at a point on EP2<sub>out</sub>; and

wherein:

 $A_1$ =R(1-cos $\phi_1$ );  $A_2$ =R(1-sin $\alpha$ ) + ( $B_2$  - Rcos $\alpha$ )cot $\alpha$ ;  $B_1$ =Rsin $\phi_1$ ; and  $B_2$ =t-Rsin $\phi_1$ .

20. (Canceled)